Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	. 14	US-4415275-\$.DID. OR US-4761269-\$.DID. OR US-5027746-\$. DID. OR US-5173327-\$.DID. OR US-6387185-\$.DID. OR US-6432231-\$.DID. OR US-6451119-\$.DID. OR US-6573182-\$. DID. OR US-6579374-\$.DID. OR US-6593484-\$.DID. OR US-6613656-\$.DID. OR US-6071572-\$.DID. OR US-6302965-\$. DID. OR US-6593484-\$.DID. OR US-6815285-\$.DID.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2006/02/17 14:04
L2	4684	700/121.ccls. or 438/478.ccls. or 118/729,719.ccls.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2006/02/17 14:46
L3	175	I2 and ((chamber or zone) and support and deposition).clm.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2006/02/17 14:47
L4	47	I3 and vertical.clm.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2006/02/17 14:47
S1	498	atomic adj layer adj deposition	US-PGPUB; USPAT	OR	ON	2006/02/13 13:26
S2	194	(atomic adj layer adj deposition) and chamber and region\$1	US-PGPUB; USPAT	OR	ON	2003/02/27 15:50
S3	94	((atomic adj layer adj deposition) and chamber and region\$1) and @ad<="20010727"	US-PGPUB; USPAT	OR	ON	2003/02/27 16:43
S4	67	(((atomic adj layer adj deposition) and chamber and region\$1) and @ad<="20010727") and wafer	US-PGPUB; USPAT	OR	ON	2003/02/27 15:51
S5	16	((((atomic adj layer adj deposition) and chamber and region\$1) and @ad<="20010727") and wafer) and support	US-PGPUB; USPAT	OR	ON	2003/02/27 15:51
S6	12	(((((atomic adj layer adj deposition) and chamber and region\$1) and @ad<="20010727") and wafer) and support) and heater	US-PGPUB; USPAT	OR	ON	2005/03/04 12:54
S7	1	"5951776".pn.	US-PGPUB; USPAT	OR	ON	2003/02/27 16:06
S8	1	"6525747".pn.	US-PGPUB; USPAT	OR	ON	2003/02/27 16:40
S9	1	"6174805".PN.	US-PGPUB; USPAT	OR	ON	2003/02/27 16:36
S10	1	"6132514".PN.	US-PGPUB; USPAT	OR	ON	2003/02/27 16:36
S11	1	"6071552".PN.	US-PGPUB; USPAT	OR	ON	2003/02/27 16:37
S12	1	"5998871".PN.	US-PGPUB; USPAT	OR	ON	2003/02/27 16:37
S13	1	"5998871".PN.	US-PGPUB; USPAT	OR	ON	2003/02/27 16:37
S14	1	"5972785".PN.	US-PGPUB; USPAT	OR	ON	2003/02/27 16:37
S15	1	"5916365".PN.	US-PGPUB; USPAT	OR	ON	2003/02/27 16:37
S16	1	"5416045".PN.	US-PGPUB; USPAT	OR	ON	2003/02/27 16:38
S 17	1	"5344792".PN.	US-PGPUB; USPAT	OR	ON	2003/02/27 16:38
S18	1	"6190732".PN.	US-PGPUB; USPAT	OR	ON	2003/02/27 16:39
S19	1	"6174377".PN.	US-PGPUB; USPAT	OR	ON	2003/02/27 16:39

		LAST Scarciffistor	•			
S20	1	"5935338".PN.	US-PGPUB; USPAT	OR	ON	2003/02/27 16:40
S21	1	"5879459".PN.	US-PGPUB; USPAT	OR	ON	2003/02/27 16:40
522	1	"5582866".PN.	US-PGPUB; USPAT	OR	ON	2003/02/27 16:40
S23	655	700/121.cds.	US-PGPUB; USPAT	OR	ON	2003/02/27 16:40
S24	213	700/121.ccls. and deposition	US-PGPUB; USPAT	OR	ON	2003/02/27 16:41
S25	113	(700/121.ccls. and deposition) and chamber	US-PGPUB; USPAT	OR	ON	2003/02/27 16:41
S26	90	((700/121.ccls. and deposition) and chamber) and @ad<="20010727"	US-PGPUB; USPAT	OR	ON	2003/03/03 14:47
S27	3	(((700/121.ccls. and deposition) and chamber) and @ad<="20010727") and piston	US-PGPUB; USPAT	OR	ON	2003/02/27 16:41
528	1	(((atomic adj layer adj deposition) and chamber and region $$1$) and @ad<="20010727") and piston	US-PGPUB; USPAT	OR	ON	2003/02/27 16:50
S29	1228	118/719.cds.	US-PGPUB; USPAT	OR	ON	2003/02/27 16:50
S30	55	118/719.ccls. and wafer and piston	US-PGPUB; USPAT	OR	ON	2003/02/27 16:50
S31	16	(118/719.ccls. and wafer and piston) and aperture	US-PGPUB; USPAT	OR	ON	2003/02/27 16:51
S 32	15	kosowski.xa.	US-PGPUB; USPAT	OR	ON	2003/03/03 14:05
S33	4183	deposition and wafer and support and chamber and region\$2 and temperature and two and gas	US-PGPUB; USPAT	OR	ON	2003/03/03 14:47
S34	3626	(deposition and wafer and support and chamber and region\$2 and temperature and two and gas) and @ad<="20010727"	US-PGPUB; USPAT	OR	ON	2003/03/03 17:34
S35	167	((deposition and wafer and support and chamber and region\$2 and temperature and two and gas) and @ad<="20010727") and piston	US-PGPUB; USPAT	OR	ON	2003/03/03 14:50
S36	11	(((deposition and wafer and support and chamber and region\$2 and temperature and two and gas) and @ad<="20010727") and piston) and monolayer	US-PGPUB; USPAT	OR	ON	2003/03/03 14:51
S37	90	((deposition and wafer and support and chamber and region\$2 and temperature and two and gas) and @ad<="20010727") and atomic adj layer	US-PGPUB; USPAT	OR	ON	2003/03/03 14:51
S38	1413684	(((deposition and wafer and support and chamber and region\$2 and temperature and two and gas) and @ad<="20010727") and atomic adj layer) and deposition near\$5 region\$1	US-PGPUB; USPAT	OR	ON	2003/03/03 14:53
S39	90	(((deposition and wafer and support and chamber and region\$2 and temperature and two and gas) and @ad<="20010727") and atomic adj layer) and (deposition near\$5 region\$1)	US-PGPUB; USPAT	OR	ON	2003/03/03 16:18
540	1	"6174805".PN.	US-PGPUB; USPAT	OR	ON	2003/03/03 15:11
S41	1	"6132514".PN.	US-PGPUB; USPAT	OR	ON	2003/03/03 15:11
S42	1	"6071552".PN.	US-PGPUB; USPAT	OR	ON	2003/03/03 15:11
S43	1	"5998871".PN.	US-PGPUB; USPAT	OR	ON	2003/03/03 15:11
S44	4	((deposition and wafer and support and chamber and region\$2 and temperature and two and gas) and @ad<="20010727") and moveable adj support	US-PGPUB; USPAT	OR	ON	2003/03/03 16:35

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S45	64	deposition and moveable adj support	US-PGPUB; USPAT	OR	ON	2003/03/03 16:35
S46	62	(deposition and moveable adj support) and @ad<="20010727"	US-PGPUB; USPAT	OR	ON	2003/03/03 16:37
S47	25	((deposition and moveable adj support) and @ad<="20010727") and wafer	US-PGPUB; USPAT	OR	ON	2003/03/03 17:16
S48	1	"5013400".PN.	US-PGPUB; USPAT	OR	ON	2003/03/03 16:45
S49	1	"4990374".PN.	US-PGPUB; USPAT	OR	ON	2003/03/03 16:45
S 50	1	"4978412".PN.	US-PGPUB; USPAT	OR	ON	2003/03/03 16:46
S51	1	"4963713".PN.	US-PGPUB; USPAT	OR	ON	2003/03/03 16:46
S 52	655	700/121.cds.	US-PGPUB; USPAT	OR	ON	2003/03/03 17:16
S53	2	700/121.cds. and atomic adj layer adj deposition	US-PGPUB; USPAT	OR	ON	2003/03/03 17:33
S54	21	interconnected with deposition with region\$2	US-PGPUB; USPAT	OR	ON	2003/03/03 17:33
\$55	21	(interconnected with deposition with region\$2) and @ad<="20010727"	US-PGPUB; USPAT	OR	ON	2003/03/04 10:10
S56	1	"4423701".pn.	US-PGPUB; USPAT	OR	ON	2003/03/04 10:10
S57	1	"4423701".pn. and (heater or temperature)	US-PGPUB; USPAT	OR	ON	2003/03/04 11:13
S58	9	(US-6524952-\$ or US-6387185-\$ or US-5916365-\$ or US-5292554-\$ or US-4423701-\$ or US-4664939-\$).did. or (US-20020197863-\$ or US-20020076490-\$ or US-20020056414-\$).did.	US-PGPUB; USPAT	OR	OFF	2003/03/04 13:26
S59	2	((US-6524952-\$ or US-6387185-\$ or US-5916365-\$ or US-5292554-\$ or US-4423701-\$ or US-4664939-\$).did. or (US-20020197863-\$ or US-20020076490-\$ or US-20020056414-\$).did.) and aperture	US-PGPUB; USPAT	OR	ON	2003/03/04 13:51
S60	0	"4423701".pn. and gase	US-PGPUB; USPAT	OR	ON	2003/03/04 13:51
S61	1	"4423701".pn. and gas	US-PGPUB; USPAT	OR	ON	2003/03/04 13:51
S62	1	"4664939".pn. and gas	US-PGPUB; USPAT	OR	ON	2003/03/04 14:09
S63	2	((US-6524952-\$ or US-6387185-\$ or US-5916365-\$ or US-5292554-\$ or US-4423701-\$ or US-4664939-\$).did. or (US-20020197863-\$ or US-20020076490-\$ or US-20020056414-\$).did.) and electrostatic	US-PGPUB; USPAT	OR	ON	2003/03/04 14:18
S64	0	((US-6524952-\$ or US-6387185-\$ or US-5916365-\$ or US-5292554-\$ or US-4423701-\$ or US-4664939-\$).did. or (US-20020197863-\$ or US-20020076490-\$ or US-20020056414-\$).did.) and piston	US-PGPUB; USPAT	OR	ON	2003/03/04 14:18
S65	18	atomic adj layer adj deposition and piston	US-PGPUB; USPAT	OR	ON	2003/03/04 14:22
S66	437	deposition and chamber and support and wafer and piston	US-PGPUB; USPAT	OR	ON	2003/03/04 14:23
S67	242	(deposition and chamber and support and wafer and piston) and region and gas	US-PGPUB; USPAT	OR	ON	2003/03/04 14:23
S68	191	((deposition and chamber and support and wafer and piston) and region and gas) and @ad<="20010727"	US-PGPUB; USPAT	OR	ON	2003/03/04 14:25

S69	94	deposition and wafer adj support and piston	US-PGPUB; USPAT	OR	ON	2003/03/04 14:25
S70	83	(deposition and wafer adj support and piston) and @ad<="20010727"	US-PGPUB; USPAT	OR	ON	2003/03/04 14:26
S71	. 8	((deposition and wafer adj support and piston) and @ad<="20010727") and wafer adj support with piston	US-PGPUB; USPAT	OR	ON	2003/03/04 14:28
S72	1	"5228502".pn.	US-PGPUB; USPAT	OR	ON	2003/03/04 14:28
S73	10	(US-6524952-\$ or US-6387185-\$ or US-5916365-\$ or US-5292554-\$ or US-4664939-\$ or US-4423701-\$ or US-5518542-\$).did. or (US-20020076490-\$ or US-20020197863-\$ or US-20020056414-\$).did.	US-PGPUB; USPAT	OR	OFF	2003/07/25 14:05
S74	1	((US-6524952-\$ or US-6387185-\$ or US-5916365-\$ or US-5292554-\$ or US-4664939-\$ or US-4423701-\$ or US-5518542-\$).did. or (US-20020076490-\$ or US-20020197863-\$ or US-20020056414-\$).did.) and elevation	US-PGPUB; USPAT	OR	ON	2003/07/25 14:06
S75	8	((US-6524952-\$ or US-6387185-\$ or US-5916365-\$ or US-5292554-\$ or US-4664939-\$ or US-4423701-\$ or US-5518542-\$).did. or (US-20020076490-\$ or US-20020197863-\$ or US-20020056414-\$).did.) and vertical	US-PGPUB; USPAT	OR	ON	2003/07/25 14:11
S76	58	dworkin.in.	US-PGPUB; USPAT	OR	ON	2003/07/28 11:14
S77	1	dworkin.in. and vendor	US-PGPUB; USPAT	OR	ON	2003/07/28 11:56
S78	20721	image adj planes	US-PGPUB; USPAT	OR	ON	2003/07/28 11:56
S79	1159	(image adj planes) and "345"/\$.ccls.	US-PGPUB; USPAT	OR	ON	2003/07/28 11:56
S80	680	118/729.cds.	US-PGPUB; USPAT	OR	ON	2003/11/17 16:10
S81	411	118/729.ccls. and (vertical or elevation)	US-PGPUB; USPAT	OR	ON	2003/11/17 16:10
S82	306	(118/729.ccls. and (vertical or elevation)) and deposition	US-PGPUB; USPAT	OR	ON	2003/11/17 16:10
S 83	50	((118/729.ccls. and (vertical or elevation)) and deposition) and chuck	US-PGPUB; USPAT	OR	ON	2003/11/17 16:10
S84	48	(((118/729.ccls. and (vertical or elevation)) and deposition) and chuck) and (zone or chamber)	US-PGPUB; USPAT	OR	ON	2003/11/17 16:11
S85	12	((((118/729.ccls. and (vertical or elevation)) and deposition) and chuck) and (zone or chamber)) and pedestal	US-PGPUB; USPAT	OR	ON	2003/11/17 16:16
S86	9	((((((118/729.ccls. and (vertical or elevation)) and deposition) and chuck) and (zone or chamber)) and pedestal) and (((118/729.ccls. and (vertical or elevation)) and deposition) and (pedestal same vertical\$3))	US-PGPUB; USPAT	OR	ON	2003/11/17 16:19
S87	32	((118/729.cds. and (vertical or elevation)) and deposition) and (pedestal same vertical\$3)	US-PGPUB; USPAT	OR	ON	2003/11/17 16:50
S88	1	"6143086".URPN.	USPAT	OR	ON	2003/11/17 16:27
S 89	16	("3306768" "3641974" "4724621" "4938815" "5065698" "5094885" "5135629" "5169684" "5192371" "5213650" "5228501" "5238499" "5304249" "5474612" "5589224" "5803977").PN.	USPAT	OR	ON	2003/11/17 16:27
S90	225	(wafer or semiconductor) and (pedestal same vertical\$4) and (mult\$4 near5 chamber\$2)	US-PGPUB; USPAT	OR	ON	2003/11/17 16:51
S91	209	((wafer or semiconductor) and (pedestal same vertical\$4) and (mult\$4 near5 chamber\$2)) and deposition	US-PGPUB; USPAT	OR	ON	2003/11/17 16:51
S92	16	"5855675".URPN.	USPAT	OR	ON	2003/11/17 16:52

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593	37	(((wafer or semiconductor) and (pedestal same vertical\$4) and (mult\$4 near5 chamber\$2)) and deposition) and chuck and heater	US-PGPUB; USPAT	OR	ON	2003/11/18 10:02
594	25	"5909994".URPN.	USPAT	OR	ON	2003/11/18 09:55
S95	58	(wafer or semiconductor) and vertical and multichamber and deposition and chuck and heater	US-PGPUB; USPAT	OR	ON	2003/11/18 10:03
S96	66	(wafer or semiconductor) and vertical and multichamber and deposition and chuck	US-PGPUB; USPAT	OR	ON	2003/11/18 10:03
S 97	201	(wafer or semiconductor) and vertical and multichamber and deposition	US-PGPUB; USPAT	OR	ON	2003/11/18 10:03
S98	172	((wafer or semiconductor) and vertical and multichamber and deposition) and (pedestal or support)	US-PGPUB; USPAT	OR	ON	2003/11/18 10:04
S99	11	(((wafer or semiconductor) and vertical and multichamber and deposition) and (pedestal or support)) and "700"/\$.ccls.	US-PGPUB; USPAT	OR	ON	2003/11/18 10:05
S10 0	2	"6178660".URPN.	USPAT	OR	ON	2003/11/18 10:12
S10 1	13	("4795299" "4917556" "5228206" "5423971" "5529657" "5611861" "5755938" "5759334" "5855675" "5863170" "5880924" "5882165" "5886864").PN.	USPAT	OR	ON	2003/11/18 10:13
S10 2	1	"4423701".pn.	US-PGPUB; USPAT	OR	ON	2003/11/18 10:23
S10 3	1	"4423701".pn. and vertical	US-PGPUB; USPAT	OR	ON	2003/11/18 10:23
510 4	15	(US-4423701-\$ or US-5292554-\$ or US-5518542-\$ or US-4664939-\$ or US-6524952-\$ or US-6387185-\$ or US-5916365-\$ or US-6143086-\$ or US-6497767-\$ or US-6178660-\$ or US-5772773-\$ or US-6318945-\$).did. or (US-20020056414-\$ or US-20020197863-\$ or US-20020076490-\$).did.	US-PGPUB; USPAT	OR	OFF .	2003/11/18 10:40
S10 5	51	multizone and deposition and wafer	US-PGPUB; USPAT	OR	ON	2003/11/18 10:45
S10 6	25	(multizone and deposition and wafer) and vertical	US-PGPUB; USPAT	OR	ON	2003/11/18 10:40
S10 7	4	((multizone and deposition and wafer) and vertical) and pedestal	US-PGPUB; USPAT	OR	ON	2003/11/18 10:42
S10 8	1	"6352593".pn.	US-PGPUB; USPAT	OR	ON	2003/11/18 10:42
S10 9	220	(multizone or multi-zone) and deposition and wafer	US-PGPUB; USPAT	OR	ON	2003/11/18 10:46
S11 0	0	((multizone or multi-zone) and deposition and wafer) and verticle	US-PGPUB; USPAT	OR	ON	2003/11/18 10:46
S11 1	126	((multizone or multi-zone) and deposition and wafer) and vertical	US-PGPUB; USPAT	OR	ON	2003/11/18 10:46
S11 2	104	(((multizone or multi-zone) and deposition and wafer) and vertical) and (support or pedestal)	US-PGPUB; USPAT	OR	ON	2003/11/18 10:46
S11 3	63	((((multizone or multi-zone) and deposition and wafer) and vertical) and (support or pedestal)) and heater	US-PGPUB; USPAT	OR	ON	2003/11/18 10:46
S11 4	27	(((((multizone or multi-zone) and deposition and wafer) and vertical) and (support or pedestal)) and heater) and chuck	US-PGPUB; USPAT	OR	ON	2003/11/18 11:12
S11 5	2	"6413321".URPN.	USPAT	OR	ON	2003/11/18 10:50
S11 6	17	("3627590" "4798165" "5045346" "5221414" "5230741" "5238499" "5244730" "5350427" "5366585" "5374594" "5447570" "5589233" "5614055" "5855681" "5871811" "5879128" "6020035").PN.	USPAT	OR	ON	2003/11/18 10:50
S11 7	1329	118/719.cds.	US-PGPUB; USPAT	OR	ON	2003/11/18 11:12

S11 73 118/719.ccds. and pedestal and vertical US-PGPUB; USPAT USPAT ON USPAT	2003/11/18 12:47 2003/11/18 11:13 2003/11/18 12:55 2003/11/18 12:55 2003/11/18 12:55
9 USPAT US	2003/11/18 12:55
0 USPAT USPAT US-PGPUB; OR ON	2003/11/18 12:55
	2003/11/18 12:55
S12 171 (118/719.ccls. and aperture) and vertical\$3 US-PGPUB; OR USPAT ON	
S12 112 ((118/719.ccls. and aperture) and vertical\$3) and wafer US-PGPUB; OR USPAT ON	2003/11/18 12:55
S12 56 ((((118/719.ccls. and aperture) and vertical\$3) and wafer) and US-PGPUB; OR USPAT ON	2003/11/18 12:57
S12 3 (((((118/719.ccls. and aperture) and vertical\$3) and wafer) and US-PGPUB; OR USPAT ON	2003/11/18 13:26
S12 30 "4430149".URPN. USPAT OR ON	2003/11/18 13:13
S12	2003/11/18 13:27
S12 257 700/121.ccls. and deposition and wafer US-PGPUB; OR USPAT ON	2003/11/18 13:27
S12 11 (700/121.ccls. and deposition and wafer) and zone and aperture US-PGPUB; OR USPAT ON	2003/11/18 13:27
S13 44138 "438"/\$.ccls. and deposition US-PGPUB; OR USPAT ON	2003/11/18 13:30
S13 12 ("438"/\$.ccls. and deposition) and pedestal and piston US-PGPUB; OR USPAT ON	2003/11/18 13:34
S13 607 438/680.ccls. US-PGPUB; OR USPAT ON	2003/11/18 13:36
S13 10 deposition and wafer adj support and (multizone or multi-zone) US-PGPUB; OR USPAT ON	2003/11/18 13:39
S13 4 cvd and pedestal same piston US-PGPUB; OR USPAT ON	2003/11/18 13:48
S13 17 ("4382739" "4513855" "4590380" "4619573" "4632624" USPAT OR	2003/11/18 13:40
S13 607 438/680.cds. US-PGPUB; OR USPAT ON	2003/11/18 13:48
S13 26 438/680.ccls. and wafer adj support US-PGPUB; OR USPAT ON	2003/11/18 14:04
S13 25 438/680.ccls. and vertical and pedestal US-PGPUB; OR USPAT ON	2003/11/18 14:04
S13 19 (438/680.ccls. and vertical and pedestal) not (438/680.ccls. and US-PGPUB; OR USPAT ON	2003/11/18 14:09
S14 8 ("4951601" "5246881" "5366585" "5516367" "5558717" USPAT OR ON "5846332" "5853607" "5885356").PN.	2003/11/18 14:06
S14 2 "6063441".URPN. USPAT OR ON	2003/11/18 14:08
S14 323 438/478.cds. US-PGPUB; OR ON USPAT	2003/11/18 14:09
S14 14 438/478.ccls. and pedestal US-PGPUB; OR ON USPAT	2003/11/18 14:12

S14							
123 Cod Clayer and deposition and support same screw and vertical) and USPAT Clayer and deposition and support same screw and vertical) and USPAT Clayer and deposition and support same screw and vertical) and USPAT Clayer and deposition and support same screw and vertical) and USPAT Clayer and concentration of the concentration o	1	690	wafer and deposition and support same screw and vertical		OR	ON	2003/11/18 14:12
column c	1	245			OR	ON	2003/11/18 14:12
Column C		123			OR	ON	2003/11/18 14:13
Site 38 deposition and wafer and ball adj screw and zone US-PGPUB; OR ON 2003/11/18 14:31 USPAT USPAT OR ON 2003/11/18 14:31 USPAT USPAT USPAT OR ON 2003/11/18 14:31 USPAT USPAT OR ON 2003/11/18 15:14 USPAT OR ON 2003/11/18 15:15 OR ON 2003/11/18 15:15 OR ON 2003/11/18 15:15 OR ON 2003/11/18 15:15 OR OR OR OR 2003/11/18 15:15 OR OR OR OR 2003/11/18 15:15 OR OR OR OR 2003/11/18 16:30 OR OR OR OR 2003/11/18 16:30 OR OR OR OR OR OR OR O	I	47		,	OR	ON	2003/11/18 14:20
Sist 275 Cord and ball adj screw US-PGPUB; OR ON 2003/11/18 14:31 US-PGPUB; OR ON 2003/11/18 15:14 US-PGPUB; OR ON 2003/11/18 15:14 US-PGPUB; OR ON 2003/11/18 15:15 OR ON 2003/11/18 16:30 OR OR ON 2003/11/18 16:30 OR OR OR OR OR OR OR O	-	24	"5620523".URPN.	USPAT	OR	ON	2003/11/18 14:20
S15	I .	38	deposition and wafer and ball adj screw and zone		OR	ON	2003/11/18 14:31
S15		275	cvd and ball adj screw		OR	ON	2003/11/18 14:31
2	•	6	(cvd and ball adj screw) and zone and aperture		OR	ON	2003/11/18 14:31
Sass655" "5916370" "6001183" "6190113" "6190460"). PN.		0	"6497767".URPN.	USPAT	OR	ON	2003/11/18 15:14
4 Image: 1 month of the content of the co		10	"5855675" "5916370" "6001183" "6190113" "6190460").	USPAT	OR	ON	2003/11/18 15:15
5 1 "6650346".pn. US-PGPUB; OR US-SCOSO3-PG-PG-PG-PG-PG-PG-PG-PG-PG-PG-PG-PG-PG-	1	1	"6497767".pn.		OR	ON	2003/11/18 16:30
Company	I	1	"6650315".pn.		OR	ON	2003/11/18 16:49
Total	1	1	"6650346".pn.		OR	ON	2003/11/18 16:50
8 US-4423701-\$ or US-5518542-\$ or US-5292554-\$ or US-56387185-\$ or US-6387185-\$ or US-6524952-\$ or US-5916365-\$ or US-6497767-\$ or US-6178660-\$ or US-5676869-\$ or US-5620523-\$ or US-6017396-\$).did. or (US-20020056414-\$ or US-20020197863-\$ or US-5676869-\$ or US-20020076490-\$).did. S15	I	46	**6551406" or "6511539" or "6481945" or "6478872" or "6447607" or "6306216" or "6305314" or "6270572" or "6231672" or "6200893" or "6197683" or "6183563" or "6174377" or "6139700" or "6042652" or "6015590" or "5916365" or "5879459" or "5855680" or "5835677" or "5807792" or "5796116" or "5730802" or "5711811" or "5674786" or "5503875" or "5483919" or "5480818" or "5443647" or "5441703" or "5374570" or "5338362" or "5294286" or "5281274" or "5261959" or "5225366" or "4993357" or "4975252" or "4834831" or "4413022" or "4389973"		OR	ON	2004/09/16 14:17
9 US-4423701-\$ or US-5518542-\$ or US-5292554-\$ or US-6387185-\$ or US-6524952-\$ or US-5916365-\$ or US-6497767-\$ or US-6178660-\$ or US-6318945-\$ or US-4430149-\$ or US-4949669-\$ or US-5676869-\$ or US-5620523-\$ or US-6017396-\$).did. or (US-20020056414-\$ or US-20020197863-\$ or US-20020076490-\$).did.) and purge S16	•	20	US-4423701-\$ or US-5518542-\$ or US-5292554-\$ or US-6387185-\$ or US-6524952-\$ or US-5916365-\$ or US-6497767-\$ or US-6178660-\$ or US-6318945-\$ or US-4430149-\$ or US-4949669-\$ or US-5676869-\$ or US-5620523-\$ or US-6017396-\$).did. or (US-20020056414-\$ or		OR	OFF	2004/09/16 16:46
0 USPAT USPAT USPAT USPAT USPAT ON 2005/03/04 12:53 516 2553 atomic adj layer adj deposition USPAT OR ON 2005/03/04 12:53 516 178 S162 and chamber and region\$ and wafer and support and heater US-PGPUB; OR ON 2005/03/04 12:54		10	US-4423701-\$ or US-5518542-\$ or US-5292554-\$ or US-6387185-\$ or US-6524952-\$ or US-5916365-\$ or US-6497767-\$ or US-6178660-\$ or US-6318945-\$ or US-4430149-\$ or US-4949669-\$ or US-5620523-\$ or US-6017396-\$).did. or (US-20020056414-\$ or		OR	ON	2004/09/16 16:46
2 S16 S162 and chamber and region\$ and wafer and support and heater US-PGPUB; OR ON 2005/03/04 12:54	1	3	"5916365".pn. or "4423701".pn. or "6497767".pn.	1	OR	ON	2004/09/17 12:45
		2553	atomic adj layer adj deposition		OR	ON	2005/03/04 12:53
		178	S162 and chamber and region\$ and wafer and support and heater		OR	ON	2005/03/04 12:54

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S16 4	18	S163 and region\$2 same (connected or interconnected)	US-PGPUB; USPAT	OR	ON	2005/03/04 12:57
S16 5	115	S163 not applied.as.	US-PGPUB; USPAT	OR	ON	2005/03/04 12:57
S16 6	84	S165 and vertical\$4	US-PGPUB; USPAT	OR	ON	2005/03/04 13:12
S16 7	1	"6174377".pn.	US-PGPUB; USPAT	OR	ON	2005/03/04 13:00
S16 8	48	("5078851" "5156820" "5294778" "5582866" "5855675" "5935338").PN. OR ("6174377").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/04 13:04
S16	42	("6174377").URPN.	USPAT	OR	OFF	2005/03/04 13:04
S17 0	23	S169 and vertical\$4	USPAT	OR	OFF	2005/03/04 13:04
S17	6	("5078851" "5156820" "5294778" "5582866" "5855675" "5935338").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/04 13:10
S17 2	67	S165 and vertical\$4 same (support or pedestal)	US-PGPUB; USPAT	OR	ON	2005/03/04 13:19
S17 3	87	ladder adj boat	US-PGPUB; USPAT	OR	ON	2005/03/04 13:19
S17	8	S173 and (ald or cvd)	US-PGPUB; USPAT	OR	ON	2005/03/04 13:50
S17	0	("6656273").URPN.	USPAT	OR	OFF	2005/03/04 13:26
S17 6	7	("5433785" "5565034" "5725664" "5759214" "6113694" "6261365" "6350316").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/03/04 13:26
S17	13	ring adj boat and (ald or cvd)	US-PGPUB; USPAT	OR	ON	2005/03/04 13:56
S17 8	87800	(ald or cvd)	US-PGPUB; USPAT	OR	ON	2005/03/04 13:56
S17 9	3603	S178 and vertical\$3 same (support or pedestal)	US-PGPUB; USPAT	OR	ON	2005/03/04 13:57
S18 0	1690	S179 and chamber same vertical\$4	US-PGPUB; USPAT	OR	ON	2005/03/04 13:57
S18	677	S180 and "118"/\$.ccls.	US-PGPUB; USPAT	OR	ON	2005/03/04 13:57
S18 2	315	S181 and process adj chamber	US-PGPUB; USPAT	OR	ON	2005/03/04 13:57
S18 3	191	S182 and vertical\$4 near5 (pedestal or support)	US-PGPUB; USPAT	OR	ON	2005/03/04 13:58
S18 4	92	S183 not applied.as.	US-PGPUB; USPAT	OR	ON	2005/03/04 14:38
S18 5	1	"6187152".pn.	US-PGPUB; USPAT	OR	ON	2005/03/04 14:39
S18 6	7120	118/715,719,729.cds. or 205/80.cds.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/04 15:33
S18 7	1	"6497676".pn.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/04 15:57

S18 8	30	(US-20020056414-\$ or US-20020076490-\$ or US-20020197863-\$).did. or (US-4423701-\$ or US-4430149-\$ or US-4664939-\$ or US-4949669-\$ or US-5292554-\$ or US-5518542-\$ or US-5620523-\$ or US-5676869-\$ or US-5772773-\$ or US-5916365-\$ or US-6017396-\$ or US-6143086-\$ or US-6178660-\$ or US-6318945-\$ or US-6387185-\$ or US-6497767-\$ or US-6524952-\$ or US-6174377-\$ or US-6800173-\$ or US-65656273-\$ or US-5759214-\$ or US-5433785-\$ or US-5725664-\$ or US-6031205-\$ or US-6365025-\$ or US-6187152-\$).did. or (US-5785796-\$).did.	US-PGPUB; USPAT	OR	OFF	2005/03/04 17:04
S18 9	18	S188 and horizontal\$4	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/04 17:16
S19 0	12	vertical adj furnace and multi-zone	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/04 17:18
S19 1	1	"6365025".pn.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/03/04 17:19
S19 3	1	"20030023338"	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/06/08 13:10
S19 4	1269	vacuum adj deposition adj chamber	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/08/23 14:21
S19 5	8	S194 and wafer with support with vertical\$3	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/08/23 13:16
S19 6	1	S195 and zone	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/08/23 13:16
S19 7	214	S194 and zone	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/08/23 13:16
S19 8	104	S197 and zone same deposition	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/08/23 13:16
S19 9	76	S197 and zone with deposition	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/08/23 13:16
S20 0	12	S197 and zone\$1 with deposition with multiple	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/08/23 13:21
S20 1	16	vertical adj furnace and vacuum adj deposition	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/08/23 13:31
S20 2	1	"6017779".pn.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/08/23 13:22
S20 3	0	("6906008").URPN.	USPAT	OR	OFF	2005/08/23 13:29
S20 4	7	("3829373" "3884787" "4562093" "4763601" "5968877" "6673387").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/23 13:29
S20 5	81	vacuum adj deposition and elevat\$3 with wafer	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/08/23 13:56

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S20 6	60	S205 and gas	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/08/23 13:56
S20 7	44	S206 and (chamber or zone)	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/08/23 13:57
S20 8	5	vacuum adj deposition adj zone	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/08/23 14:22
S20 9	41	vacuum adj deposition and multiple near3 zone\$1	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/08/23 14:23
S21 0	12	S209 and (wafer or substrate) with support	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/08/23 14:23
S21 1	8	("3006737" "3020129" "4154870" "4910163" "5810934" "6110290").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/23 15:21
S21 2	0	("6281098").URPN.	USPAT	OR	OFF	2005/08/23 15:33
S21 3	4	"917842"	USPAT	OR	OFF	2005/08/23 15:34
S21 4	0	"20030023338"	USPAT	OR	OFF	2005/08/23 15:34
S21 -5	1	"0023338"	USPAT	OR	OFF	2005/08/23 15:34
S21 6	1	"20030023338"	US-PGPUB; USPAT	OR	OFF	2005/08/23 15:35
S21 7	47	deposition adj region\$1 with multiple	US-PGPUB; USPAT	OR	OFF	2005/08/23 16:07
S21 8	1	S216 and monolayer	US-PGPUB; USPAT	OR	OFF	2005/08/23 15:39
\$21 9	1	"6383989".pn.	US-PGPUB; USPAT	OR	OFF	2005/08/23 16:07
S22 0	4	("5850071" "6051371" "6117266" "6214706").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/23 17:19
S22 1	739	chemisor\$5 and monolayer and (wafer or substrate) and (support or pedestal)	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/23 17:20
S22 2	498	S221 and vacuum and deposition	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/24 10:40
S22 3	55	S222 and (vertical or elevat\$3) with (pedestal or platform or support)	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/23 17:24
S22 4	13	US-6630201-\$.DID. OR US-6660126-\$.DID. OR US-6716287-\$. DID. OR US-6718126-\$.DID. OR US-6734020-\$.DID. OR US-6772072-\$.DID. OR US-6773507-\$.DID. OR US-6777352-\$. DID. OR US-6778762-\$.DID. OR US-6818094-\$.DID. OR US-6821563-\$.DID. OR US-6866746-\$.DID. OR US-6868859-\$. DID.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/23 17:26
S22 5	7	"20010014371" "20010013312" "20010042523" "20010054377" "20020000196" "20020009544"	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/23 17:27

S22 6	22	"20020007790" "20020041931" "20020052097" "20020066411" "20020076508" "20020076507" "20020076481" "20020073924" "20020086106" "20020094689" "20020092471" "20020104481" "20020108570" "20020121342" "20020121241" "20020127745" "20020134307" "20020146511" "20020144657" "20020144655"	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/23 17:29
S22 7	28	"20030224723" "20030010451" "20030022338" "20030042630" "20030053799" "20030057527" "20030072913" "20030075925" "20030075273" "20030079686" "20030089308" "20030101927" "20030106490" "20030113187" "20030116087" "20030121608" "20030121469" "20030143747" "20030143328" "20030140854"	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/23 17:30
S22 8	21	"20030153177" "20030172872" "20030194493" "20030198754" "20030216981" "20030213560" "20030221780" "20030224107" "20040015300" "20040014320" "20040013577" "20040011504" "20040011404" "20040016404" "20040025370" "20040065255" "20040071897" "20040069227" "20040144311" "20040144308" "20050006799"	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/23 17:31
S22 9	91	S224 or S225 or S226 or S227 or S228	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/23 17:31
S23 0	3	S229 and piston	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/23 17:32
S23 1	1	S230 and (zone with deposition)	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/23 17:33
S23 2	1650	118/719.cds.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/24 16:47
S23 3	100	S232 and piston	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/23 17:33
S23 4	3	S233 and monolayer	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/23 17:34
S23 5	1	S234 and (vertical or elevat\$3)	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/23 17:34
S23 6	62	vacuum and deposition and (raised and lowered) same wafer adj support	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/24 10:41
S23 7	8936	vacuum and deposition and (raised and lowered) withwafer adj support	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/24 10:41
S23 8	34	vacuum and deposition and (raised and lowered) with wafer adj support	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/24 10:43
S23 9	1	"6455098".pn.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/24 10:44

S24 0	41	(US-20020056414-\$ or US-20020076490-\$ or US-20020146511-\$ or US-20020195056-\$ or US-20020197863-\$ or US-20020164849-\$).did. or (US-4423701-\$ or US-4430149-\$ or US-4664939-\$ or US-4949669-\$ or US-5292554-\$ or US-5384008-\$ or US-5433785-\$ or US-5518542-\$ or US-5620523-\$ or US-5676869-\$ or US-5725664-\$ or US-5759214-\$ or US-5772773-\$ or US-5785796-\$ or US-6031205-\$ or US-6017396-\$ or US-6143086-\$ or US-6174377-\$ or US-6143080-\$ or US-6178660-\$ or US-6187152-\$ or US-6281098-\$ or US-6310281-\$).did. or (US-6318945-\$ or US-6365025-\$ or US-6656273-\$ or US-6800173-\$ or US-6906008-\$ or US-6455098-\$).did.	US-PGPUB; USPAT	OR	OFF	2005/08/24 16:39
S24 1	6	S240 and vacuum adj deposition	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/08/24 16:41
S24 2	16	vacuum adj deposition and "700"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/08/24 16:43
S24 3	3	vacuum adj deposition adj chamber and "700"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/08/24 16:41
S24 4	16	S240 and vacuum with deposition	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/08/24 16:47
S24 5	425	vacuum adj deposition and chamber same zone	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/08/24 16:47
S24 6	142	118/719.ccls. and vacuum adj deposition	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/24 16:55
S24 7	1536	atomic adj layer adj deposition and vacuum	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/24 16:55
S24 8	90	atomic adj layer adj deposition and vacuum adj deposition	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/24 16:55
S24 9	1	"2002110991"	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/12/29 13:40
S25 0	19	"110991"	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/12/29 13:40
S25 1	1	"20020110991"	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/12/29 13:42
S25 2	1	"20020009896"	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/12/29 13:43
S25 3	1	"5173327".pn.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/12/29 13:44
S25 4	1	"5972430".pn.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2006/02/17 14:46

\$25 5	14	US-4415275-\$.DID. OR US-4761269-\$.DID. OR US-5027746-\$. DID. OR US-5173327-\$.DID. OR US-6387185-\$.DID. OR US-6432231-\$.DID. OR US-6451119-\$.DID. OR US-6573182-\$. DID. OR US-6579374-\$.DID. OR US-6593484-\$.DID. OR US-6613656-\$.DID. OR US-6071572-\$.DID. OR US-6302965-\$. DID. OR US-6593484-\$.DID. OR US-6815285-\$.DID.	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/12/29 13:59
S25 6	11	"20030004723" or "20030017697" or "20030101938" or "20030219942" or "20030235961" or "20040219784" or "20040224506" or "20040235285" or "20050059240" or "20050095859" or "20050104142"	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/12/29 14:01
S25 7	1	"20050104142"	US-PGPUB; USPAT; EPO; JPO	OR	OFF	2005/12/29 14:01
S25 8	13	("4433951" "4888199" "5232508" "5262201" "5314574" "5492718" "5695568" "5734165" "5848670" "5882419" "5891251" "5951775" "6183564").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/29 14:34
S25 9	20	("4917556" "4951601" "4951602" "4962726" "4981408" "4990047" "5019234" "5024747" "5062758" "5063031" "5071791" "5092728" "5092729" "5110248" "5110249" "5231839" "5310410" "5685963" "5695564" "5871587"). PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/12/29 14:54
S26 0	13	("6183564").URPN.	USPAT	OR	OFF	2005/12/29 14:56
S26 1	50	("6139700" "6174377" "6465371" "6509280" "6610169" "6613656" "6656282" "6730164" "6734020" "6756318" "6784049" "6812157" "6815350" "6858085" "6902620" "6911092" "6916374" "6921555" "6932871" "6967154" "6596133" "6573184" "6579372" "6638879" "6740977" "6796316" "6835919" "5854138" "6344116" "6764940" "6482740" "6806145" "6887795" "6902624" "6042652" "5879459" "6200893" "6305314" "6380081" "6387185" "6451119" "6451695" "6461436" "6475276" "6475910" "6540838" "6551929" "6576053" "6602784" "6630201").pn.	USPAT	OR	OFF	2005/12/29 15:05
S26 7	14	US-4415275-\$.DID. OR US-4761269-\$.DID. OR US-5027746-\$. DID. OR US-5173327-\$.DID. OR US-6387185-\$.DID. OR US-6432231-\$.DID. OR US-6451119-\$.DID. OR US-6573182-\$. DID. OR US-6579374-\$.DID. OR US-6593484-\$.DID. OR US-6613656-\$.DID. OR US-6071572-\$.DID. OR US-6302965-\$. DID. OR US-6593484-\$.DID. OR US-6815285-\$.DID.	US-PGPUB; USPAT	OR	ON	2006/02/13 13:28
S26 8	11	"20030004723" "20030017697" "20030101938" "20030219942" "20030235961" "20040219784" "20040224506" "20040235285" "20050059240" "20050095859" "20050104142"	US-PGPUB; USPAT	OR .	ON	2006/02/13 13:49
S26 9	3	"5384008".pn. or "6281098".pn. or "6139695".pn.	US-PGPUB; USPAT	OR	ON	2006/02/13 13:55
S27 0	226	(deposition and wafer and chamber and vertical\$4).clm.	US-PGPUB; USPAT	OR	ON	2006/02/13 13:55
S27 1	21	S270 and (zone or curtain).clm.	US-PGPUB; USPAT	OR	ON	2006/02/13 14:50

2/17/06 3:04:10 PM C:\Documents and Settings\akosowski\My Documents\EAST\Workspaces\09917842.wsp Page 13